



PATENT APPLICATION

IN THE U.S. PATENT AND TRADEMARK OFFICE

December 16, 2009

Applicants: Masashi KUMAGAI et al

For: COPPER ELECTROLYTIC SOLUTION AND  
ELECTROLYTIC COPPER FOIL PRODUCED THEREWITH

Serial No.: 10/531 645 Group: 1795

Confirmation No.: 1483

Filed: April 15, 2005 Examiner: Mendez

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Atty. Docket No.: 4700.P0312US

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

LETTER TRANSMITTING APPEAL BRIEF FEE

Sir:

Enclosed is Appellants' check in the sum of \$540.00 representing payment of the Appeal Brief fee. The Commissioner is hereby authorized to charge any additional fee which may be required by this paper, or to credit any overpayment, to Deposit Account No. 06-1382.

Respectfully submitted,

  
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Encl: Appellants' Brief on Appeal  
Claims Appendix  
Evidence Appendix  
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CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Assistant Commissioner for Patents, Washington, DC 20231 on December 16, 2009.

  
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